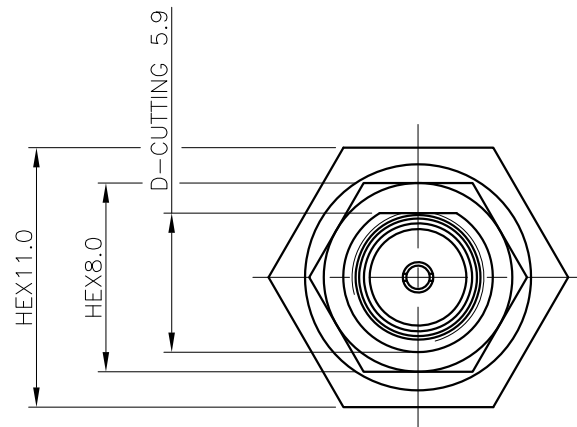
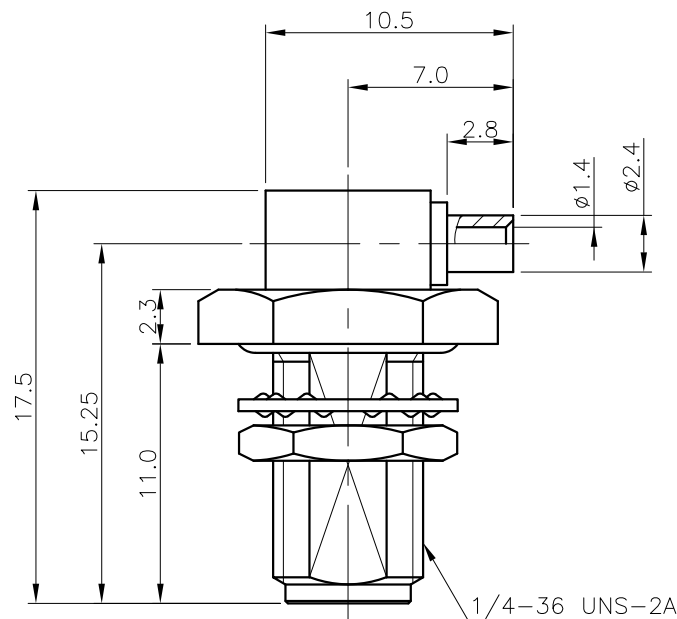
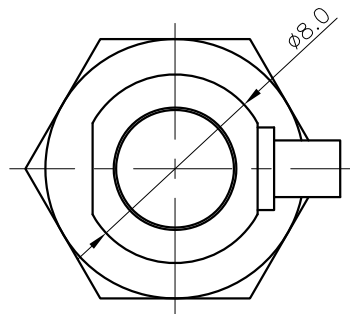
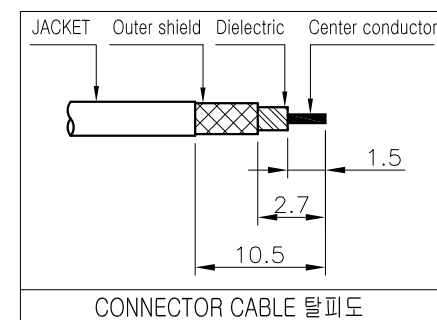




REVISION

REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	S.H.KIM		2023.05.04.

* BODY 억지끼움 받침 JIG : DEQ01244-1/1



8	WASHER	1	BsS	Gold Plate	DWA00005-5/1
7	NUT	1	MBsBD C3604BD-F	Gold Plate	DNT00025-5/1
6	COVER	1	MBsBD C3604BD-F	Gold Plate	DCO00026-5/2
5	INSULATOR	1	TEFLON		DIN00981-N/1
4	GASKET	1	SILICONE	RED	DGK00023-N/2
3	CONTACT	1	BeCu C17300	Gold Plate	DCT04298-5/1
2	BODY	1	MBsBD C3604BD-F	Gold Plate	DBD04814-5/1
1	BODY	1	MBsBD C3604BD-F	Gold Plate	DBD04813-5/2
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal ±0.2	DATE 2023. 05. 04.			 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017	
	Angle ±1°	APPROVED BY				
MATERIAL _____		CHECKED BY			TITLE SMA50 CABLE JL-BH 47F	
		DRAWN BY S.H.KIM				
FINISH _____		SCALE 3/1	UNIT mm		A4	DWG NO. CN04044-7/2
						REVISION I R